

## 500V 28A N-channel Enhancement Mode Power MOSFET

### Description

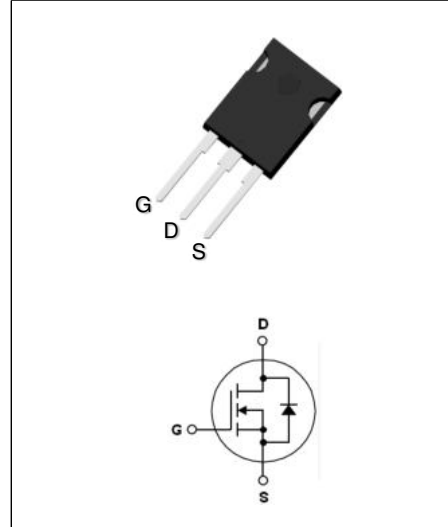
The AKT28N50S is an N-Channel enhancement mode power MOSFET which using proprietary planar stripe and DMOS technology. This MOSFET has low static on-resistance and high avalanche energy strength. This device provide excellent switching performance for UPS,DC-DC converters and AC-DC power supply.

### Features

- Low on-Resistance:  $R_{DS(on)}=0.14\Omega(\text{typ.})$
- Special Process Technology for high ESD Capability
- 100% Avalanche Test
- Good Stability and Uniformity with High  $E_{AS}$

### Applications

- UPS Applications
- DC-DC Converters and AC-DC Power Supply



### Absolute Maximum Ratings @ $T_C=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Ratings	Unit	
$V_{DSS}$	Drain to Source Voltage	500	V	
$V_{GSS}$	Gate to Source Voltage	$\pm 30$	V	
$I_D$	Drain Current	$T_C=25^\circ\text{C}$	28	A
		$T_C=100^\circ\text{C}$	18	A
$I_{DM}$	Pulsed Drain Current (Note1)	126	A	
$P_D$	Maximum Power Dissipation	$T_C=25^\circ\text{C}$	310	W
	Derate above $25^\circ\text{C}$		2.5	W/ $^\circ\text{C}$
$E_{AS}$	Single Pulsed Avalanche Energy (Note 2)	3048	mJ	
$T_J$	Operating Junction Temperature Range	-55~+150	$^\circ\text{C}$	
$T_{STG}$	Storage Temperature Range	-55~+150	$^\circ\text{C}$	

### Thermal Characteristics

Symbol	Parameter	Ratings	Unit
$R_{th(J-C)}$	Thermal Resistance, Junction to case	0.40	$^\circ\text{C}/\text{W}$
$R_{th(J-A)}$	Thermal Resistance, Junction to Ambient	40	$^\circ\text{C}/\text{W}$

## Electrical Characteristics @ $T_C=25\text{ }^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$BV_{DSS}$	Drain to Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	500	-	-	V
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	3.0	3.59	5	V
$R_{DS(on)}$	Static Drain-Source On-Resistance	$V_{GS}=10V, I_D=14A$	-	0.14	-	$\Omega$
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=V_{DSS}, V_{GS}=0V$	-	-	1	$\mu A$
$I_{GSS}$	Gate to Source Leakage Current	$V_{GS}=V_{GSS}, V_{DS}=0V$	-	-	$\pm 100$	nA

## D-S Diode Characteristics and Maximum Rating @ $T_C=25\text{ }^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_S$	Maximum Drain to Source Diode Forward Current		-	-	28	A
$V_{SD}$	Drain-Source Diode Forward Voltage	$V_{GS}=0V, I_S=28A$	-	0.935	1.1	V
$t_{rr}$	Reverse Recovery Time	$V_{GS}=0V, I_S=28A,$	-	-	0.4	$\mu s$
$Q_{rr}$	Reverse Recovery Charge	$di/dt=-100A/\mu s$	-	6.1	-	$\mu C$

## Switching Characteristics @ $T_C=25\text{ }^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on Delay Time	$I_D=28A,$ $V_{DD}=250V,$ $R_G=25\Omega$ (Note 3)	-	110	-	ns
$t_r$	Rising Time		-	310	-	ns
$t_{d(off)}$	Turn-off Delay Time		-	210	-	ns
$t_f$	Falling Time		-	195	-	ns
$C_{iss}$	Input Capacitance	$V_{GS}=0V, V_{DS}=25V,$ $f=1.0MHz$	-	4700	-	pF
$C_{oss}$	Output Capacitance		-	680	-	pF
$C_{riss}$	Reverse Transfer Capacitance		-	70	-	pF
$Q_g$	Total Gate Charge	$I_D=28A,$ $V_{DS}=400V$ $V_{GS}=10V$ (Note 3)	-	115	-	nC
$Q_{gs}$	Gate to Source Charge		-	30	-	nC
$Q_{gd}$	Gate to Drain Charge		-	54	-	nC

### Note:

1. Repetitive rating: pulse-width limited by maximum junction temperature
2.  $L=5mH, V_{DD}=100V, V_G=10V, @T_C=25\text{ }^\circ\text{C}$
3. Essentially independent of operating temperature typical characteristics

**Typical Characteristics**

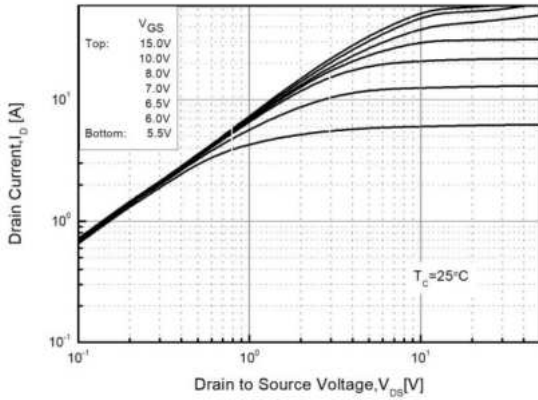


Figure 1. On-Region Characteristics

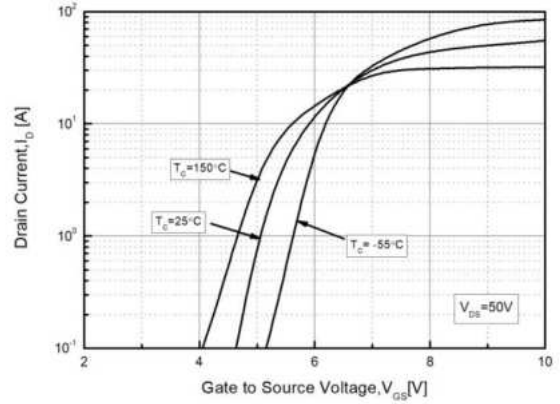


Figure 2. Transfer Characteristics

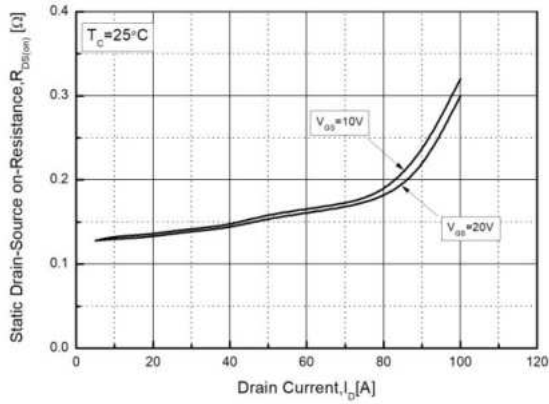


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

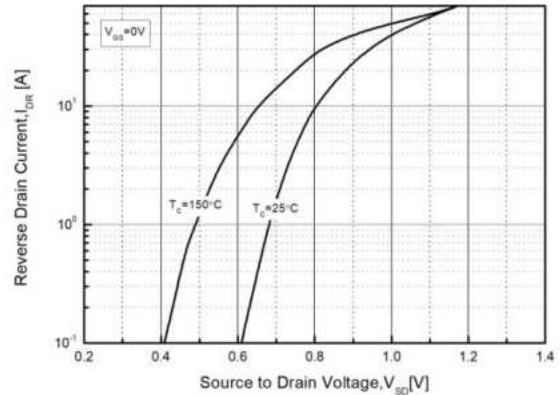


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

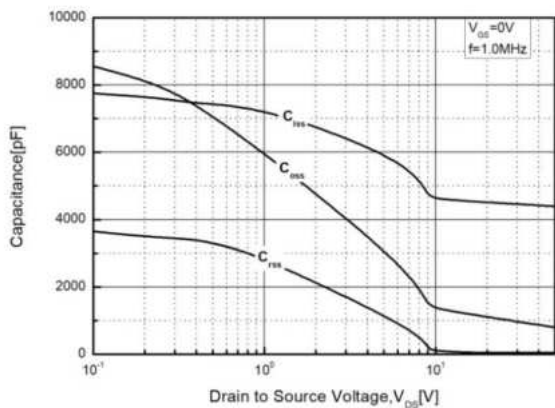


Figure 5. Capacitance Characteristics

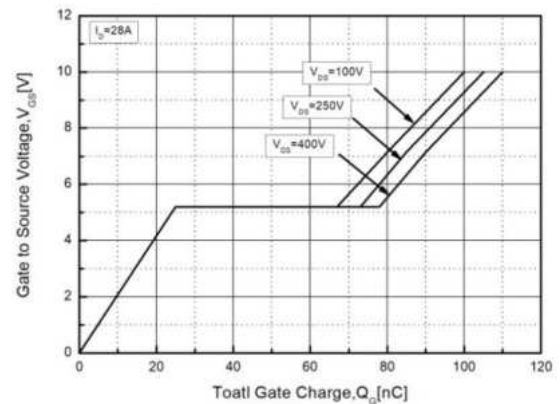


Figure 6. Gate Charge Characteristics

**Typical Characteristics** (Continued)

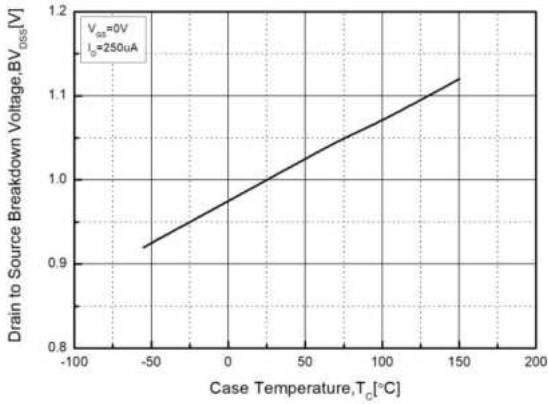


Figure 7. Breakdown Voltage Variation vs. Temperature

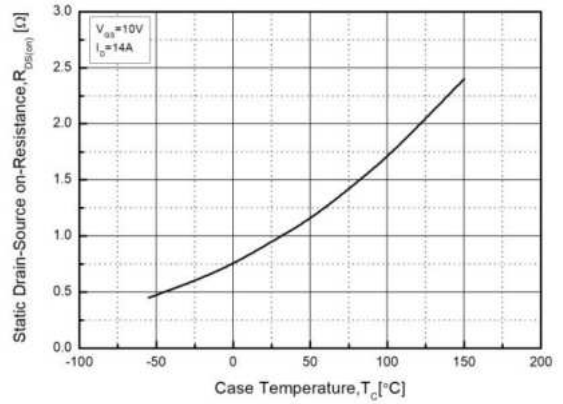


Figure 8. On-Resistance Variation vs. Temperature

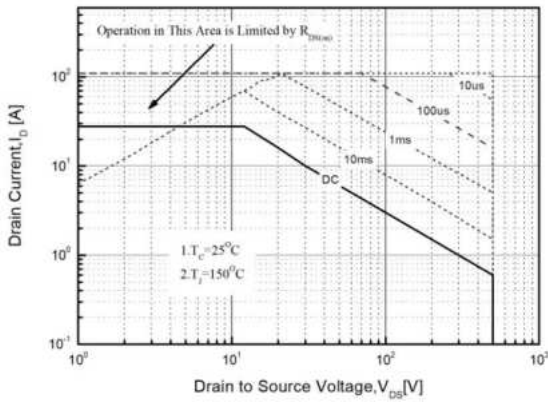


Figure 9. Maximum Safe Operating Area

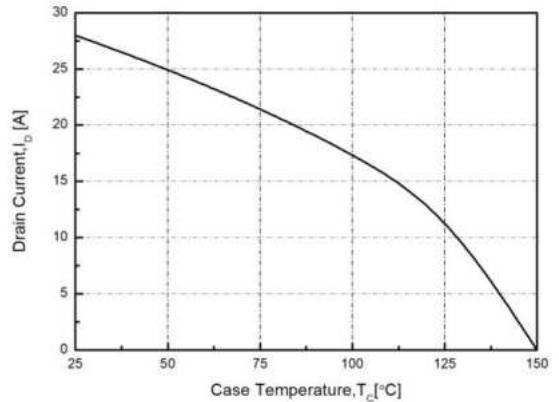


Figure 10. Maximum Drain Current vs. Case Temperature

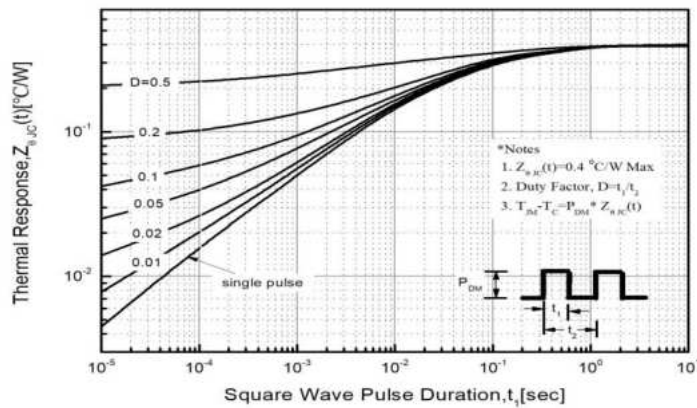


Figure 11. Transient Thermal Response Curve

**Package Dimensions**

**Super TO-247**

(Dimensions in Millimeters)

